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- All Outputs Are High for Invalid Input Conditions
- Also for Application as 4-Line-to-16-Line Decoders 3-Line-to-8-Line Decoders
- Diode-Clamped Inputs

	TYPICAL	TYPICAL
TYPES	POWER	PROPAGATION
	DISSIPATION	DELAYS
'42A	140 mW	17 ns
'LS42	35 mW	17 ns

description

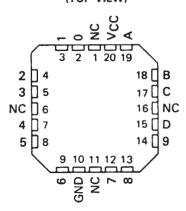
These monolithic BCD-to-decimal decoders consist of eight inverters and ten four-input NAND gates. The inverters are connected in pairs to make BCD input data available for decoding by the NAND gates. Full decoding of valid input logic ensures that all outputs remain off for all invalid input conditions.

The '42A and 'LS42 feature inputs and outputs that are compatible for use with most TTL and other saturated low-level logic circuits. DC noise margins are typically one volt.

The SN5442A and SN54LS42 are characterized for operation over the full military temperature range of -55 °C to 125 °C. The SN7442A and SN74LS42 are characterized for operation from 0 °C to 70 °C. SN5442A, SN54LS42...J OR W PACKAGE SN7442A...N PACKAGE SN74LS42...D OR N PACKAGE (TOP VIEW)

0	∐ 1	U16	Vcc
1		15] A
2		14	В
3	4	13	l c
4	5	12	D
5	6	11	9
6	<u>ر</u>]	10	8
GND	<u>[8</u>	9] 7

SN54LS42 . . . FK PACKAGE (TOP VIEW)



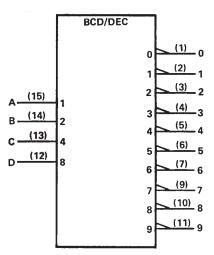
NC - No internal connection

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



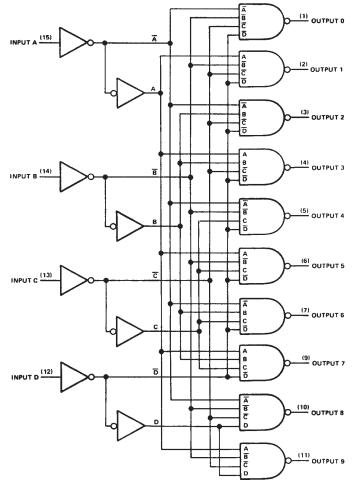
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logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)

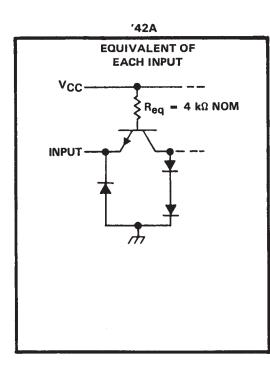


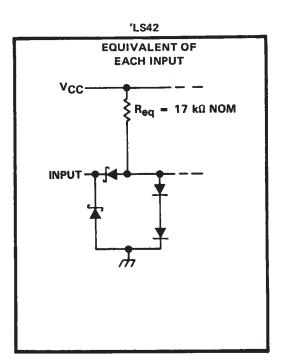
Pin numbers shown are for D, J, N, and W packages.

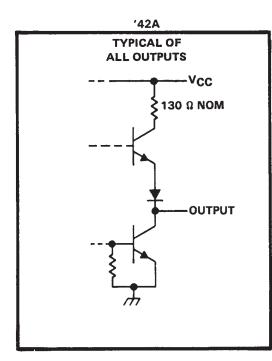


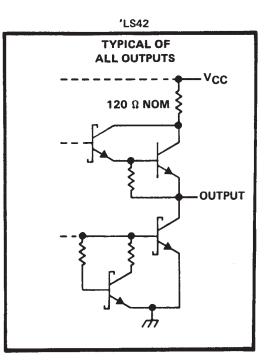
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schematics of inputs and outputs











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						FUNC	TION 1	ABLE						
		BCD I	NPUT					DEC	MAL (DUTPU	т			
NO.	D	С	В	Α	0	1	2	3	4	5	6	7	8	9
0	L	L	L	L	L	н	н	н	н	Н	Н	н	н	Н
1	L	L	L	н	н	L	н	н	н	н	н	н	н	н
2	L	L	н	L	н	н	L	н	н	н	н	н	н	н
3	L	L	н	н	н	н	н	L	н	н	н	н	н	н
4	L	н	L	L	н	н	н	н	L	н	н	н	н	н
5	L	Н	L	н	н	н	н	Н	н	L	н	Н	н	Н
6	L	н	н	L	н	н	н	н	н	н	L	н	н	н
7	L	н	н	н	н	н	н	н	н	Н	н	L	н	н
8	н	L	L	L	н	н	н	н	н	н	н	н	L	н
9	н	L	L	н	н	н	н	н	н	Н	н	н	н	L_
	н	L	н	L	н	н	н	н	н	Н	Н	н	Н	н
	н	L	н	н	н	н	н	н	н	н	н	н	н	н
INVALID	н	н	L	L	н	н	н	н	н	н	н	н	н	н
	н	н	L	н	н	н	н	н	н	н	н	н	н	н
5	н	н	н	L	н	н	н	н	н	н	н	н	н	н
1	н	н	н	н	н	н	H	н	н	н	н	н	н	н

H = high level, L = low level

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Input voltage: '42A	
'LS42	7V
Operating free-air temperature range: SN5442A, SN54LS42	–55°C to 125°C
SN7442A, SN74LS42	
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.



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recommended operating conditions

	s	SN5442A			SN7442A			
	MIN	NOM	MAX	MIN	NOM	MAX	1	
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH			-800			- 800	μA	
Low-level output current, IOL			16			16	mA	
Operating free-air temperature, T _A	-55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS [†]	s	SN5442	Α		A	UNIT	
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.8			0.8	V
Vik	Input clamp voltage	$V_{CC} = MIN$, $I_I = -12 \text{ mA}$			-1.5			-1.5	V
v _{он}	High-level output voltage	$V_{CC} = MIN, V_{IH} = 2V,$ $V_{IL} = 0.8V, I_{OH} = -800 \ \mu A$	2.4	3.4		2.4	3.4		v
V _{OL}	Low-level output voltage	$V_{CC} = MIN, V_{IH} = 2V,$ $V_{1L} = 0.8V, I_{OL} = 16 mA$		0.2	0.4		0.2	0.4	v
4	Input current at maximum input voltage	V _{CC} = MAX, V ₁ = 5.5 V			1			1	mA
Чн	High-level input current	V _{CC} = MAX, V ₁ = 2.4 V			40			40	μA
4L	Low level input current	V _{CC} = MAX, V _I = 0.4 V			-1.6			-1.6	mA
los	Short-circuit output current §	V _{CC} = MAX	-20		-55	-18		-55	mA
Icc	Supply current	V _{CC} = MAX, See Note 2	[28	41		28	56	mA

[†]For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions.

[‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$.

\$ Not more than one output should be shorted at a time.

NOTE 2: I_{CC} is measured with all outputs open and all inputs grounded.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
^t PHL	Propagation delay time, high-to-low-level			14	25	ns
	output from A, B, C, or D through 2 levels of logic	4				
tPHL	Propagation delay time, high-to-low-level output from A, B, C, or D through 3 levels of logic	С _L = 15 рF,		17	30	ns
	Propagation delay time, low-to-high-level					
^t PLH	output from A, B, C, and D through 2 levels of logic	See Note 3		10	25	ns
touu	Propagation delay time, low-to-high-level	7		17	30	ns
^t PLH	output from A, B, C, and D through 3 levels of logic					

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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recommended operating conditions

	S	N54LS4	12	S	UNIT		
	MIN	MIN NOM MAX			NOM	MAX	
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-400			-400	μA
Low-level output current, IOL			4			8	mA
Operating free-air temperature, T _A	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TE	ST CONDITIC	Net	S	N54LS4	2	S	N74LS4	2	
	PARAMETER	IE:	STCONDITIC)N5'	MIN	MIN TYP [‡] MAX		MIN	TYP [‡]	MAX	UNIT
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage	V _{CC} = MIN,	lj = -18 mA				1.5			-1.5	V
v _{он}	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, I _{OH} = -400	μA	2.5	3.5		2.7	3.5		v
Val		V _{CC} = MIN,	V _{IH} ≈ 2 V,	I _{OL} = 4 mA		0.25	0.4		0.25	0.4	v
VOL	Low-level output voltage	VIL = VIL max		1 _{OL} = 8 mA					0.35	0.5	
II.	Input current at maximum input voltage	V _{CC} = MAX,	V ₁ = 7 V				0.1			0.1	mA
ŧн	High-level input current	V _{CC} = MAX,	V ₁ = 2.7 V				20			20	μA
ΊL	Low-level input current	V _{CC} = MAX,	VI = 0.4 V				-0.4			-0.4	mA
los	Short-circuit output current§	V _{CC} = MAX			-20		-100	-20		-100	mA
Icc	Supply current	V _{CC} = MAX,	See Note 2	-	_	7	13		7	13	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C. [§]Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second. NOTE 2. ICC is measured with all outputs open and inputs grounded.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
₽HL	Propagation delay time, high-to-low-level output from A, B, C, or D through 2 levels of logic			15	25	ns
^t ΡHL	Propagation delay time, high-to-low-level	C _L = 15 pF,		20	30	ns
чп <u>г</u>	output from A, B, C, or D through 3 levels of logic Propagation delay time, low-to-high-level	$R_{\rm L} = 2 k\Omega,$		20		
₽LH	output from A, B, C, and D through 2 levels of logic	See Note 3		15	25	ns
^t PLH	Propagation delay time, low-to-high-level output from A, B, C, and D through 3 levels of logic			20	30	ns

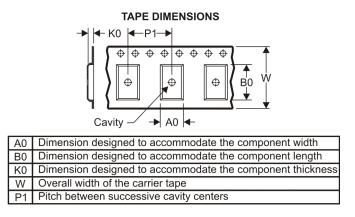
NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions a	are nominal
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Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS42NSR	SO	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



PACKAGE MATERIALS INFORMATION

11-Mar-2008



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS42NSR	SO	NS	16	2000	346.0	346.0	33.0

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